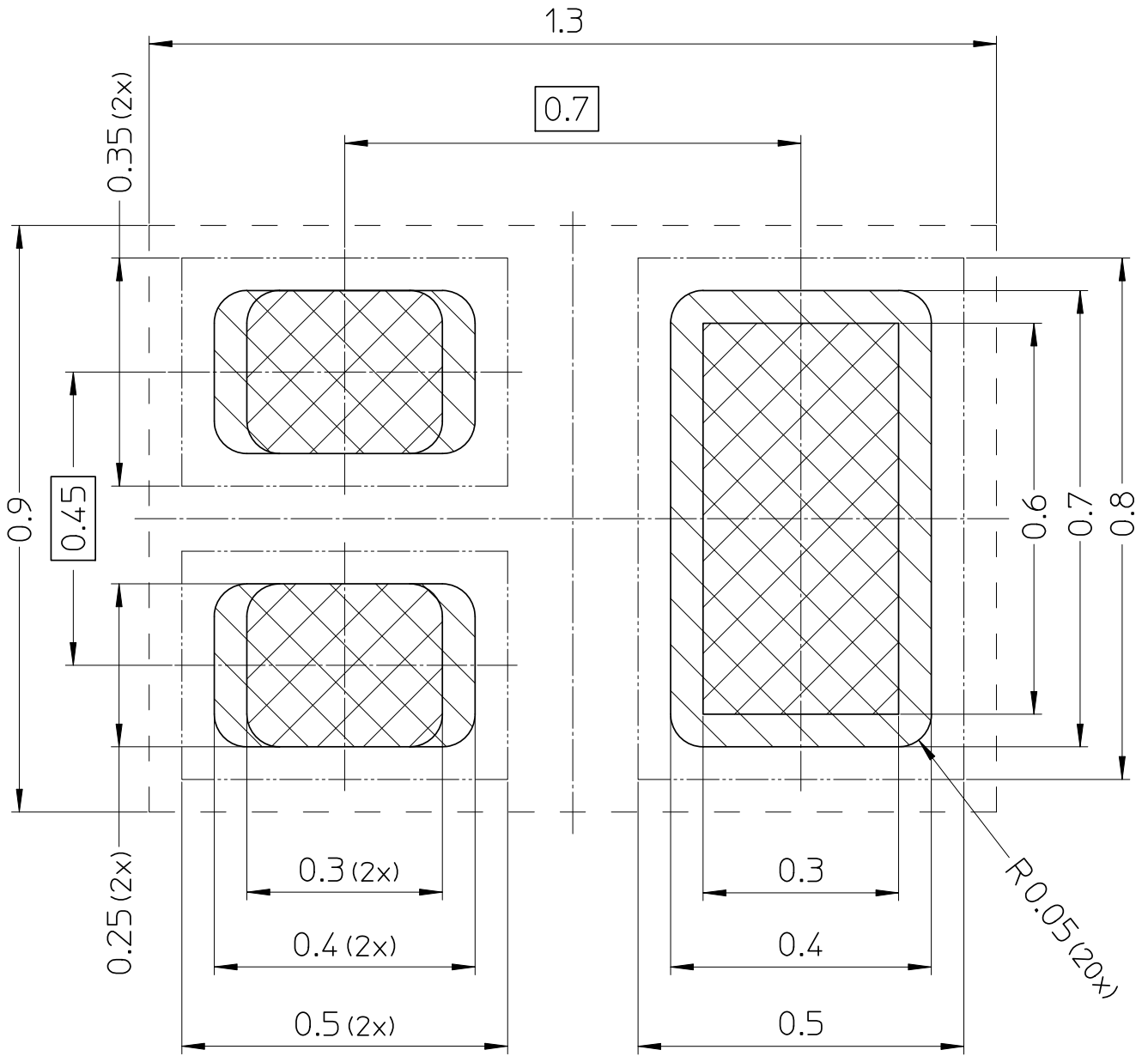




All rights are reserved. Reproduction in whole or in part is prohibited without the written consent of the copyright owner.



- Occupied Area
- Solder Resist
- Solder Lands
- Solder Paste

REFLOW SOLDERING

	Scale 100:1	Unit mm	Tol. unless otherw. stated ±	ISO 1302 Ra in µm	ISO 1101 A	Typ u a.
FOOTPRINT		SOT883		4312 258 01227		2011-12-23
Name: WK Ho		DWG No.: EH1487		110 - 1		010 - - - A 4
PV	Check :	Dat.: 2007-12-07		(c) NXP Semiconductors / TCC		